

ABSTRACT

5 A film adhesive including metal particles, an epoxy resin, a phenolic resin, and an elastomer, in which a content of the metal particles is 80.0% by mass or more based on a mass of the film adhesive, the epoxy resin includes a first epoxy resin that is liquid at 25°C and a second epoxy resin that is solid at 25°C, and when the content of the metal particles is 100 parts by mass, the content of the first epoxy resin is 4.0 to 5.5 parts by mass.

Fig. 1